

General Description

The SJS2305B uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as -2.5V. This device is suitable for use as a wide variety of applications.

Features

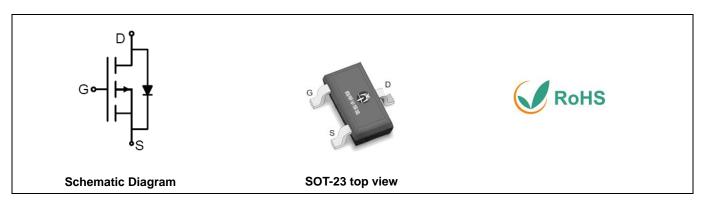
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	-20	V
R _{DS(ON)_TYP}	34.3	mΩ
I _D	-4.2	A
Q _G	9.1	nC



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJS2305B	2305	SOT-23	Tape	\	\	3000 Pcs

Table 1. Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	-20	V
V _{GS}	Gate-Source Voltage (V _{DS} =0V)	±12	
	Drain Current-Continuous(T _A =25℃)		А
I _D	Drain Current-Continuous(T _A =100 °C)	-2.6	А
I _{DM} (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-16.8	А
Б	Maximum Power Dissipation(T _A =25°C)		W
P _D	Maximum Power Dissipation(T _A =100 °C)	0.4	W
E _{AS}	Avalanche energy (Note 2)	25 m	
TJ, TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
R _θ JA	Thermal Resistance, Junction-to-Ambient		112	°C/W



Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

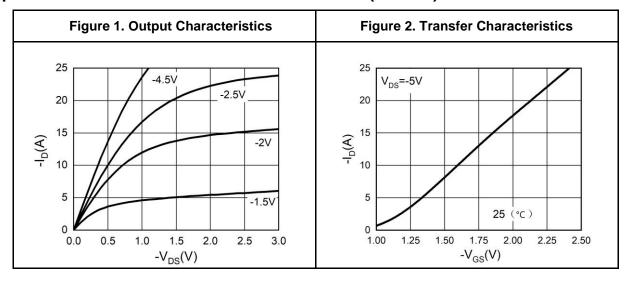
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =-250μA	-20			V
	7 0 1 1/1 1 5 1 0 1	V _{DS} =-20V, V _{GS} =0V T _J =25℃			-1	μΑ
IDSS	Zero Gate Voltage Drain Current	V _{DS} =-20V, V _{GS} =0V T _J =125℃			-100	μΑ
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±12V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA	-0.5		-1	V
g FS	Forward Transconductance	V _{DS} =-5V, I _D =-3A		13.6		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-4.5V, I _D =-3A T _J =25℃		34.3	44.6	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-2.5V, I _D =-2A T _J =25℃		44.4	57.7	mΩ
Dynamic Chara	cteristics					
Ciss	Input Capacitance			854		pF
Coss	Output Capacitance	V _{DS} =-10V,V _{GS} =0V, f=1.0MHz		150		pF
Crss	Reverse Transfer Capacitance			90		pF
Switching Para	meters					
t _{d(on)}	Turn-on Delay Time			11		nS
tr	Turn-on Rise Time	V _{GS} =-4.5V, V _{DS} =-15V,		34		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time	$R_L=2.5\Omega$, $R_{GEN}=3\Omega$		55		nS
t _f	Turn-Off Fall Time			51		nS
Qg	Total Gate Charge			9.1		nC
Q _{gs}	Gate-Source Charge	V _{GS} =-4.5V, V _{DS} =-10V, I _D =-3A		1.6		nC
Q_gd	Gate-Drain Charge			2		nC
Source-Drain D	iode Characteristics			•	•	•
I _{SD}	Source-Drain Current (Body Diode)				-4.2	Α
V_{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =-3A			-1.2	V

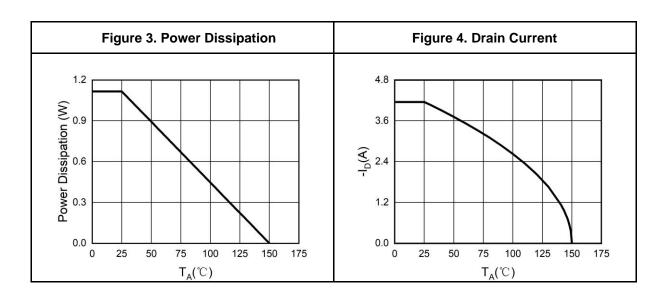
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature. Notes 2.E_{AS} condition: T_J=25 $^{\circ}$ C,V_{DD}=-20V,V_G=-10V, Rg=25 $^{\circ}$ C, L=0.5mH.

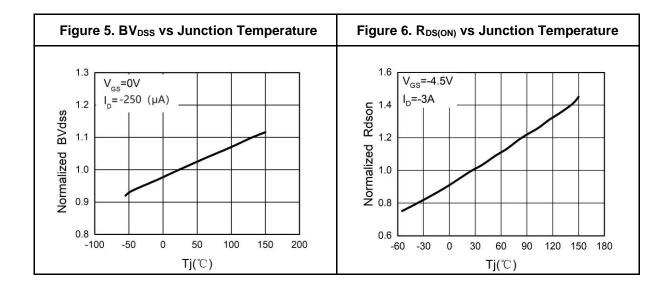
Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



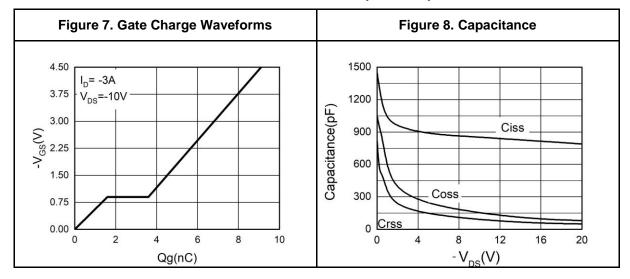
Typical Electrical And Thermal Characteristics (Curves)

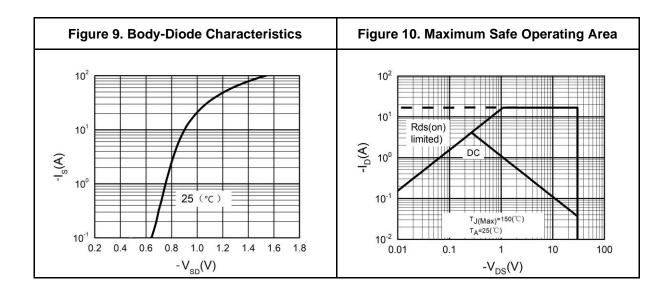






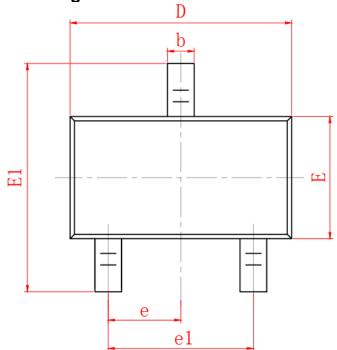
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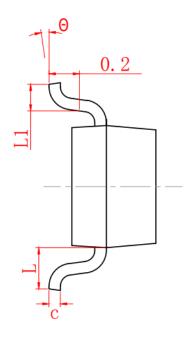


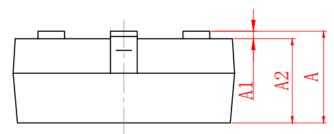




SOT-23 Package Information







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SYMBOL	MIN	NOM	MAX	
А	0.90	1.05	1.20	
A1	0.00	0.05	0.10	
A2	0.90	1.00	1.10	
b	0.30	0.40	0.50	
С	0.08	0.10	0.15	
D	2.80	2.90	3.00	
E	1.20	1.30	1.40	
E1	2.30	2.40	2.50	
L	0.30	0.40	0.50	
θ	0°	5°	10°	
L1	0.55 REF			
е	0.95 BSC			
e1	1.90 REF			

Attention

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